## Surface Mount Schottky Power Rectifier

## MBRS120T3G, <br> SBRS8120T3G, SBRS8120N

This device employs the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity protection diodes in surface mount applications where compact size and weight are critical to the system.

## Features

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop ( 0.55 Volts Max @ $1.0 \mathrm{~A}, \mathrm{~T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ )
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guard-Ring for Stress Protection
- ESD Ratings:
- Human Body Model = 3B (> 16000 V )
- Machine Model = C (> 400 V )
- SBRS8 Prefix for Automotive and Other Applications Requiring

Unique Site and Control Change Requirements; AEC-Q101
Qualified and PPAP Capable*

- These are $\mathrm{Pb}-$ Free Devices


## Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 95 mg (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: $260^{\circ} \mathrm{C}$ Max. for 10 Seconds
- Cathode Polarity Band

ON Semiconductor ${ }^{\circledR}$
www.onsemi.com
SCHOTTKY BARRIER RECTIFIER
1.0 AMPERE, 20 VOLTS

(Note: Microdot may be in either location)
**The Assembly Location code (A) is front side optional. In cases where the Assembly Location is stamped in the package bottom (molding ejecter pin), the front side assembly code may be blank.

ORDERING INFORMATION

| Device | Package | Shipping $^{\dagger}$ |
| :---: | :---: | :---: |
| MBRS120T3G | SMB <br> (Pb-Free) | $2500 /$ <br> Tape \& Reel |
| SBRS8120T3G* $^{\star}$ | SMB <br> (Pb-Free) | $2500 /$ <br> Tape \& Reel |
| SBRS8120NT3G* | SMB <br> (Pb-Free) | $2500 /$ <br> Tape \& Reel |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MBRS120T3G, SBRS8120T3G, SBRS8120N

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
| :--- | :---: | :---: | :---: |
| Peak Repetitive Reverse Voltage <br> Working Peak Reverse Voltage <br> DC Blocking Voltage | $\mathrm{V}_{\mathrm{RRM}}$ <br> $\mathrm{V}_{\mathrm{RWM}}$ <br> $\mathrm{V}_{\mathrm{R}}$ | 20 | V |
| Average Rectified Forward Current <br> $\left(\mathrm{T}_{\mathrm{L}}=115^{\circ} \mathrm{C}\right)$ | $\mathrm{I}_{\mathrm{F}(\mathrm{AV})}$ | 1.0 | A |
| Non-Repetitive Peak Surge Current <br> (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz$)$ | $\mathrm{I}_{\mathrm{FSM}}$ | 40 | A |
| Operating Junction Temperature | $\mathrm{T}_{\mathrm{J}}$ | -65 to +125 | ${ }^{\circ} \mathrm{C}$ |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: |
| Thermal Resistance, Junction-to-Lead <br> $\left(\mathrm{T}_{\mathrm{L}}=25^{\circ} \mathrm{C}\right)$ | $\mathrm{R}_{\text {өJL }}$ | 12 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## ELECTRICAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
| :--- | :---: | :---: | :---: |
| Maximum Instantaneous Forward Voltage (Note 1) <br> $\left(\mathrm{i}_{\mathrm{F}}=1.0 \mathrm{~A}, \mathrm{~T}_{J}=25^{\circ} \mathrm{C}\right)$ | $\mathrm{V}_{\mathrm{F}}$ |  | V |
| Maximum Instantaneous Reverse Current (Note 1) <br> (Rated dc Voltage, $\left.\mathrm{T}_{J}=25^{\circ} \mathrm{C}\right)$ <br> (Rated dc Voltage, $\mathrm{T}_{J}=100^{\circ} \mathrm{C}$ ) | $\mathrm{i}_{\mathrm{R}}$ |  | mA |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. Pulse Test: Pulse Width $=300 \mu \mathrm{~s}$, Duty Cycle $\leq 2.0 \%$.

## TYPICAL CHARACTERISTICS



Figure 1. Typical Forward Voltage


Figure 2. Typical Reverse Current


Figure 3. Typical Capacitance


Figure 4. Current Derating (Case)


Figure 5. Power Dissipation


SCALE 1:1


SCALE 1:1

SMB
CASE 403A-03
ISSUE J
DATE 19 JUL 2012

Polarity Band Non-Polarity Band


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
DIMENSION b SHALL BE MEASURED WITHIN DIMENSION L1

|  | MILLIMETERS |  |  | INCHES |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DIM | MIN | NOM | MAX | MIN | NOM | MAX |
| A | 1.95 | 2.30 | 2.47 | 0.077 | 0.091 | 0.097 |
| A1 | 0.05 | 0.10 | 0.20 | 0.002 | 0.004 | 0.008 |
| b | 1.96 | 2.03 | 2.20 | 0.077 | 0.080 | 0.087 |
| C | 0.15 | 0.23 | 0.31 | 0.006 | 0.009 | 0.012 |
| D | 3.30 | 3.56 | 3.95 | 0.130 | 0.140 | 0.156 |
| E | 4.06 | 4.32 | 4.60 | 0.160 | 0.170 | 0.181 |
| HE | 5.21 | 5.44 | 5.60 | 0.205 | 0.214 | 0.220 |
| L | 0.76 | 1.02 |  |  | 1.60 | 0.030 |
| L1 | 0.040 |  |  | 0.063 |  |  |

## GENERIC MARKING DIAGRAM*



Non-Polarity Band
XXXXX = Specific Device Code
A = Assembly Location
Y = Year
WW = Work Week

- $\quad$ Pb-Free Package
(Note: Microdot may be in either location)
*This information is generic. Please refer to device data sheet for actual part marking. $\mathrm{Pb}-$ Free indicator, " G " or microdot " $\mathrm{\nabla}$ ", may or may not be present.
*For additional information on our $\mathrm{Pb}-$ Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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| ---: | :--- | :--- | :--- |
| DESCRIPTION: | SMB | PAGE 1 OF 1 |

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SK32A-LTP SK33A-TP SK34B-TP SS3003CH-TL-E GA01SHT18 CRS10I30A(TE85L,QM MA4E2501L-1290 MBRB30H30CT-1G SB007-03C-TB-E SK32A-TP SK33B-TP SK35A-TP SK38B-TP NRVBM120LT1G NTE505 NTSB30U100CT-1G SS15E-TP VS6CWQ10FNHM3 ACDBA1100LR-HF ACDBA1200-HF ACDBA140-HF ACDBA2100-HF ACDBA3100-HF CDBQC0530L-HF CDBQC0240LR-HF ACDBA340-HF ACDBA260LR-HF ACDBA1100-HF SK310B-TP MA4E2502L-1246 MA4E2502H-1246 NRVBM120ET1G NSR01L30MXT5G NTE573


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